TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

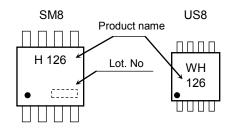
TC7WH126FU, TC7WH126FK

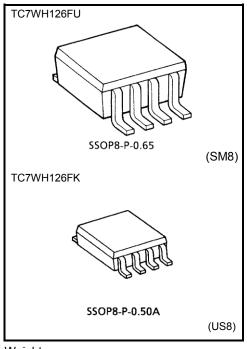
Dual Bus Buffer with 3-state Output

Features

- High speed: t_{pd} = 3.8 ns (typ.) at V_{CC} = 5.0 V, C_L = 15 pF
- Low power dissipation: I_{CC} = 2 μA (max) at Ta = 25°C
- High noise immunity: V_{NIH} = V_{NIL} = 28% V_{CC} (min)
- 5.5 V tolerant inputs
- Balanced propagation delays : $t_{pLH} \approx t_{pHL}$
- Wide operating voltage range: V_{CC} = 2.0 to 5.5 V
- Low Noise : V_{OLP} = 0.8V (max)

Marking





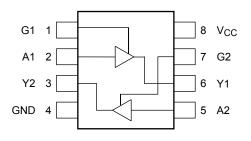
Weight

SSOP8-P-0.65 : 0.02 g (typ.) SSOP8-P-0.50A : 0.01 g (typ.)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	−0.5 to 7.0	V
DC input voltage	V _{IN}	−0.5 to 7.0	٧
DC output voltage	V _{OUT}	-0.5 to $V_{CC} + 0.5$	٧
Input diode current	I _{IK}	-20	mA
Output diode current	lok	±20 (Note1)	mA
DC output current	lout	±25	mA
DC V _{CC} /ground current	I _{CC}	±50	mA
Power dissipation	P _D	300(SM8) 200(US8)	mW
Storage temperature	T _{stg}	−65 to 150	°C
Lead temperature (10 s)	TL	260	°C

Pin Assignment (top view)



Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1:V_{OUT} < GND, V_{OUT} > V_{CC}

Start of commercial production 1997-02

IEC Logic Symbol



Truth Table

G	Α	Υ
L	Х	Z
Н	L	L
Н	Н	Н

X: Don't care

Z: High impedance

Operating Ranges

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	2.0 to 5.5	V
Input voltage	V _{IN}	0 to 5.5	V
Output voltage	V _{OUT}	0 to V _{CC}	V
Operating temperature	T _{opr}	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 100 (V_{CC} = 3.3 V ± 0.3 V)	ns/V
	di/dv	0 to 20 (V_{CC} = 5.0V ± 0.5 V)	TIS/V



Electrical Characteristics

DC Characteristics

Characteristics Symbol Test Condition				Ta = 25°C				Ta = -40 to 85°C			
Characteristics	Symbol	rest Condition		V _{CC} (V) Min	Min	Тур.	Max	Min	Max	Unit	
High-level input		_		2.0	1.5	_	_	1.5	_		
voltage	V _{IH}			3.0 to 5.5	V _{CC} × 0.7	_	_	V _{CC} × 0.7	_	V	
Low-level input				2.0	_	_	0.5	_	0.5		
voltage	V_{IL}		_	3.0 to 5.5	_	_	V _{CC} × 0.3	_	$\begin{array}{c} V_{CC} \\ \times \ 0.3 \end{array}$	V	
				2.0	1.9	2.0	_	1.9			
			$I_{OH} = -50 \mu A$	3.0	2.9	3.0	_	2.9			
High-level output voltage	V _{OH}	$V_{IN} = V_{IH}$		4.5	4.4	4.5	_	4.4		V	
			$I_{OH} = -4 \text{ mA}$	3.0	2.58	_	_	2.48			
			$I_{OH} = -8 \text{ mA}$	mA 4.5 3.94 — -	_	3.8	_				
		V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	2.0 — 0.0	0.1	_	0.1				
				$I_{OL} = 50 \mu A$	3.0	_	0.0	0.1	_	0.1	
Low-level output voltage	V_{OL}			4.5	_	0.0	0.1	_	0.1	V	
			$I_{OL} = 4 \text{ mA}$	3.0	_	_	0.36	_	0.44		
			$I_{OL} = 8 \text{ mA}$	4.5	_	_	0.36	_	0.44		
3-state output off-state current	I _{OZ}	V _{IN} = V _{IH} or V _{IL} V _{OUT} = V _{CC} or GND		5.5	_	_	±0.25	_	±2.5	μА	
Input leakage current	I _{IN}	V _{IN} = 5.5V or GND		0 to 5.5	_		±0.1	_	±1.0	μА	
Quiescent supply current	Icc	$V_{IN} = V_{CC}$	or GND	5.5		_	2.0		20.0	μА	

3

AC Characteristics	(unless	otherwise	specified,	input:	$t_r = t_f =$	3 ns)
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Characteristics Symbol		Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit		
			V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Min	Max		
			3.3 ± 0.3	15	_	5.6	8.0	1.0	9.5		
Propagation delay	t_{pLH}		3.3 ± 0.3	50	_	8.1	11.5	1.0	13.0	ns	
time	t_{pHL}	_	5.0 ± 0.5	15	_	3.8	5.5	1.0	6.5	115	
			5.0 ± 0.5	50	_	5.3	7.5	1.0	8.5		
			3.3 ± 0.3	15	_	5.4	8.0	1.0	9.5		
3-state output	t_{pZL}	R _L =1kΩ	3.3 ± 0.3	50	_	7.9	11.5	1.0	13.0	ns	
enable time	t _{pZH}		5.0 ± 0.5	15	_	3.6	5.1	1.0	6.0		
					5.0 ± 0.5	50	_	5.1	7.1	1.0	8.0
3-state output	t _{pLZ}	RL=1kΩ	3.3 ± 0.3	50	_	9.5	13.2	1.0	15.0	ns	
disable time	t_{pHZ}	KL-1K32	5.0 ± 0.5	50	_	6.1	8.8	1.0	10.0	115	
Output to Output	t _{osLH}	(Note 2)	3.3 ± 0.3	50	_	_	1.5	_	1.5	ns	
Slew	t _{osHL}	(Note 2)	5.0 ± 0.5	50	_	_	1.0	_	1.0	115	
Input capacitance	C _{IN}		_		_	4	10	_	10	pF	
Output capacitance	C _{OUT}		_		_	6	_	_	_	pF	
Power dissipation capacitance	C _{PD}			(Note 3)		15		_	_	pF	

Note 2: Parameter guaranteed by design. $t_{osLH} = |t_{pLHm} - t_{pLHn}|$, $t_{osHL} = |t_{pHLm} - t_{pHLn}|$

Note 3: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

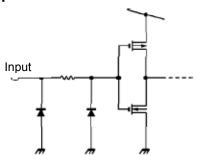
Average operating current can be obtained by the equation:

$$I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2$$

Noise Characteristics (Ta=25°C, Input tr= tf = 3ns)

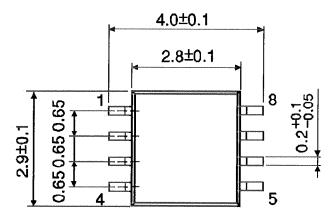
Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Limit	Unit
Quiet Output Maximum Dynamic V _{OL}	V _{OLP}	C _L = 50pF	5.0	0.3	0.8	V
Quiet Output Minimum Dynamic V _{OL}	V _{OLV}	C _L = 50pF	5.0	-0.3	-0.8	V
Minimum High Level Dynamic Input Voltage	V _{IHD}	C _L = 50pF	5.0	_	3.5	V
Maximum Low Level Dynamic Input Voltage	V _{ILD}	C _L = 50pF	5.0	_	1.5	V

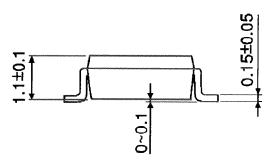
Input Equivalent Circuit



Package Dimensions

SSOP8-P-0.65 Unit: mm



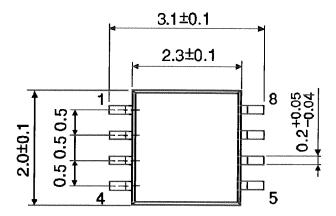


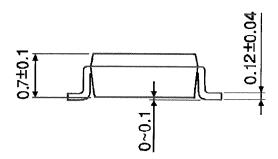
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Weight: 0.02 g (typ.)

Package Dimensions

SSOP8-P-0.50A Unit: mm





6

Weight: 0.01 g (typ.)

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